

**GigaDevice Semiconductor Inc.**

**Arm<sup>®</sup> Cortex<sup>®</sup>-M3/4/23/33 32-bit MCU**

**Application Note**

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## 1. Introduction

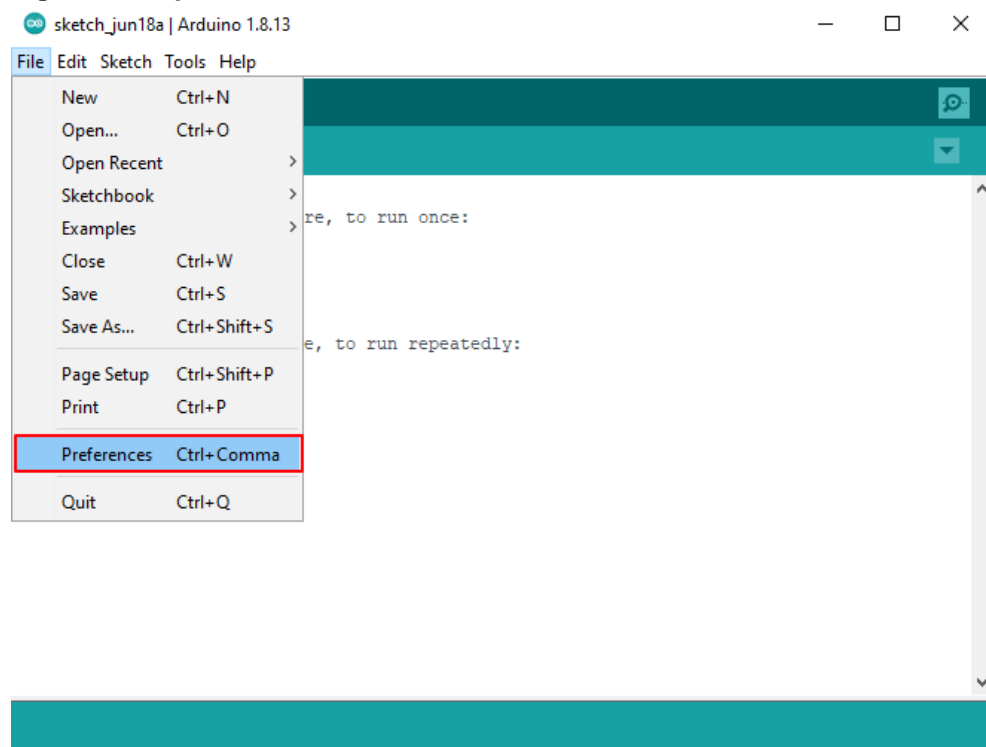
This Application Note describes how to configure and develop a GD32 MCU project using the Arduino IDE, the processes are described in the following paragraphs.

## 2. Install gd32 library

Users can install the gd32 library by the following steps.

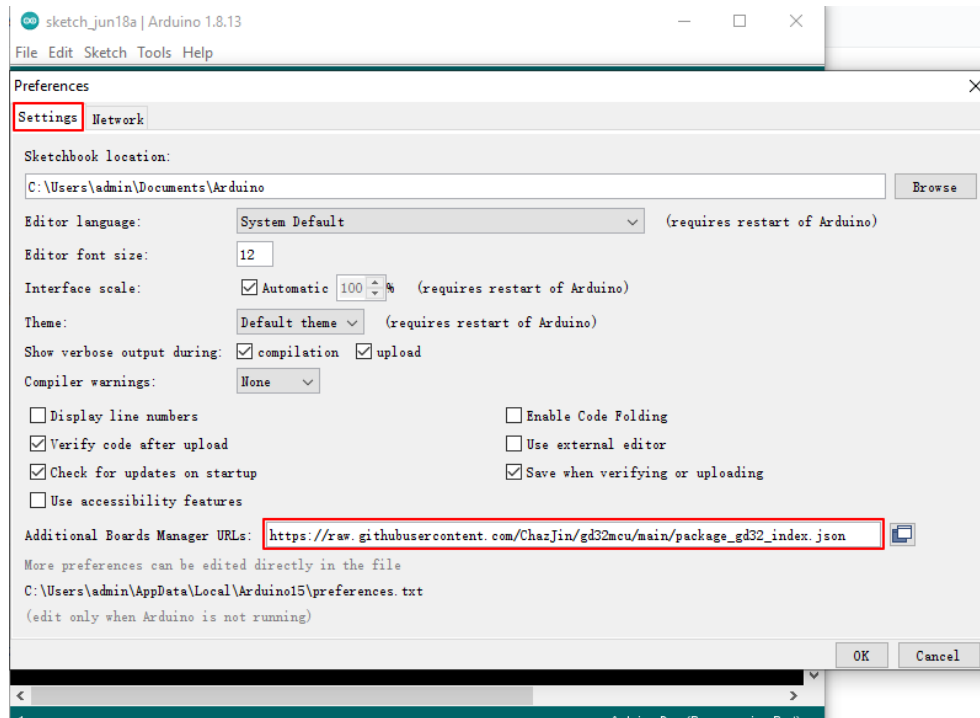
1. Open the Preferences

**Figure 2-1. Open the Preferences**



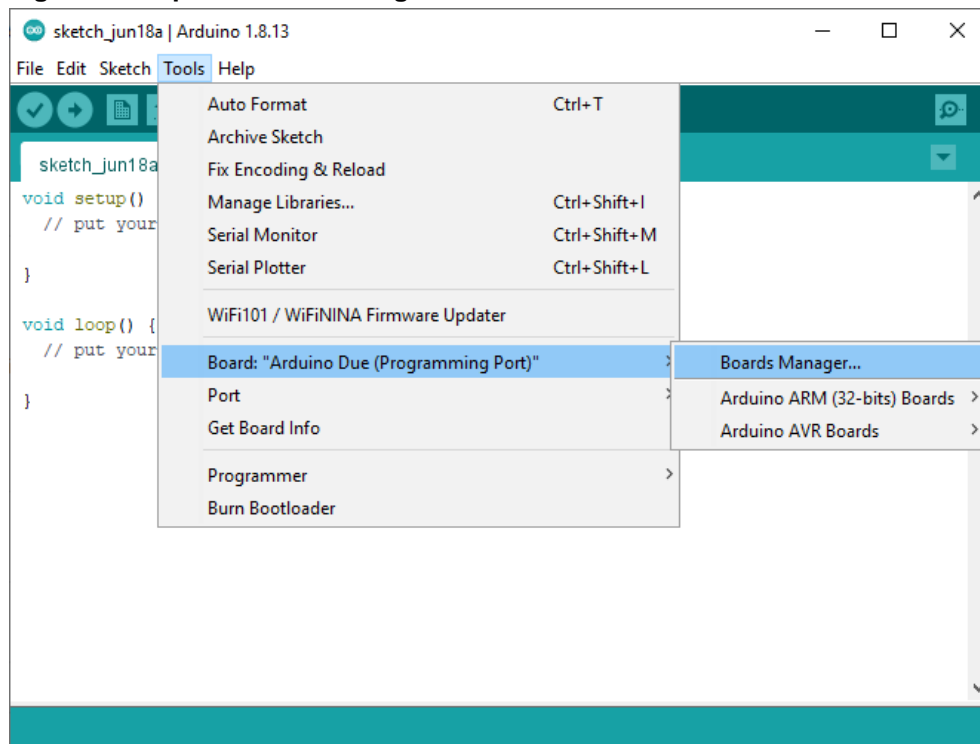
2. Add gd32 package url, then click "OK" button.

**Figure 2-2. Add gd32 package url**



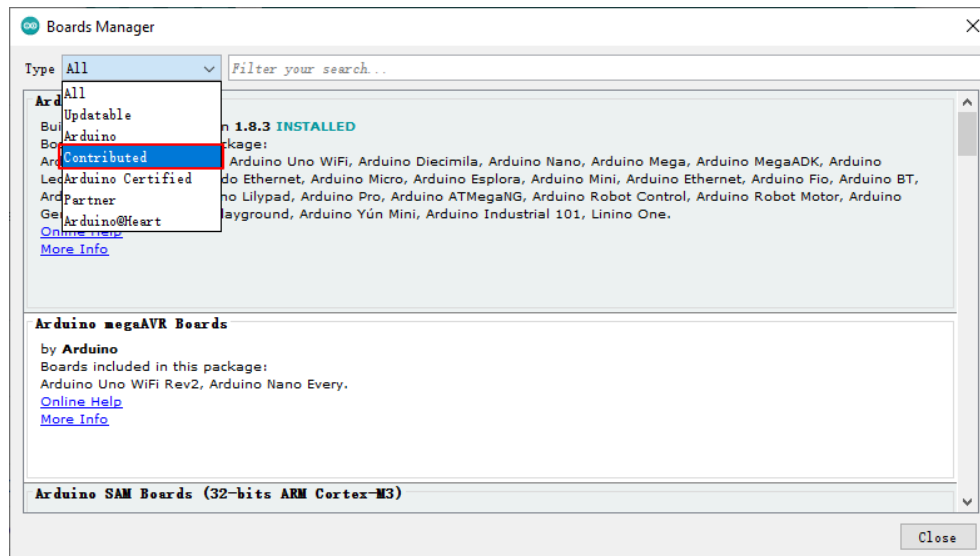
### 3. Open boards manager

**Figure 2-3. Open boards manager**



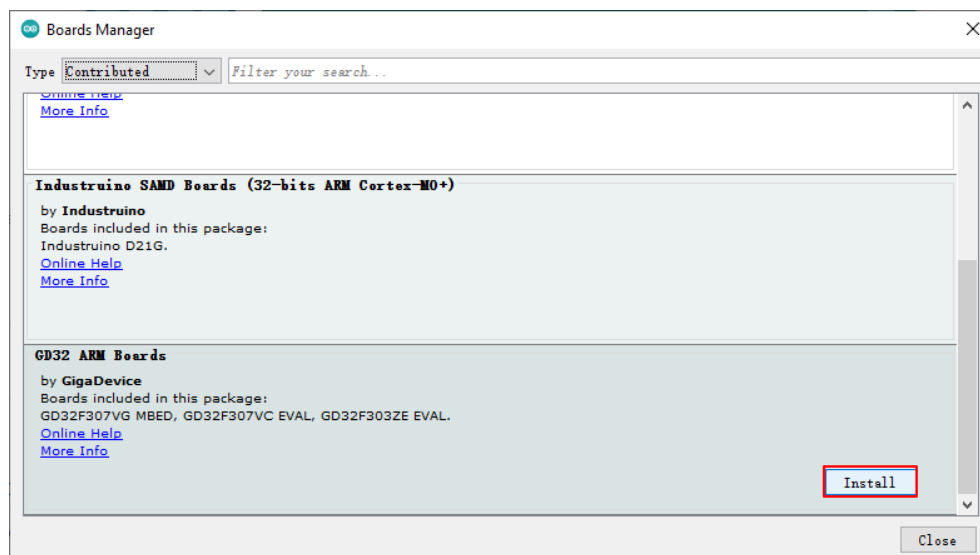
### 4. Select contributed type.

**Figure 2-4. Select contributed type**

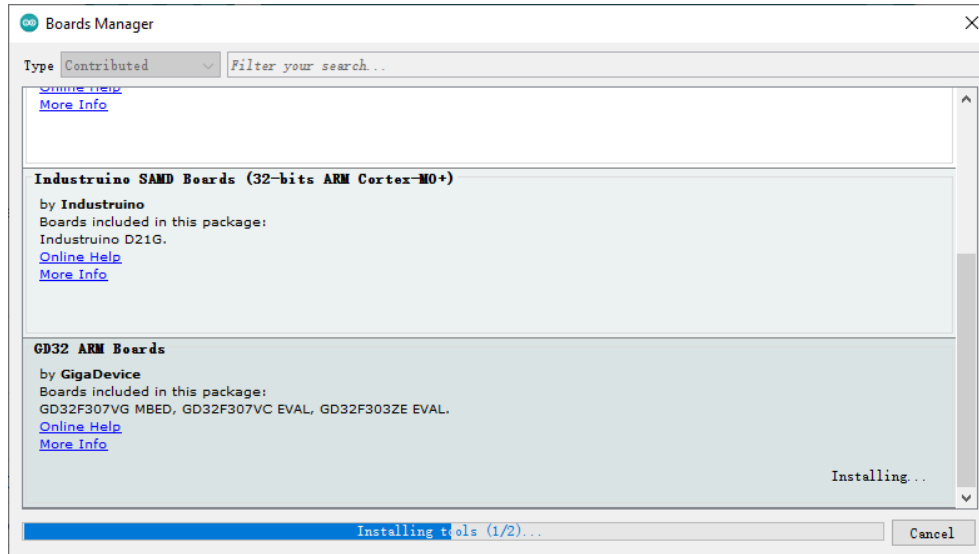


5. Select GD32 ARM Boards to install.

**Figure 2-5. Select GD32 ARM Boards to install**



**Figure 2-6. Install the board**



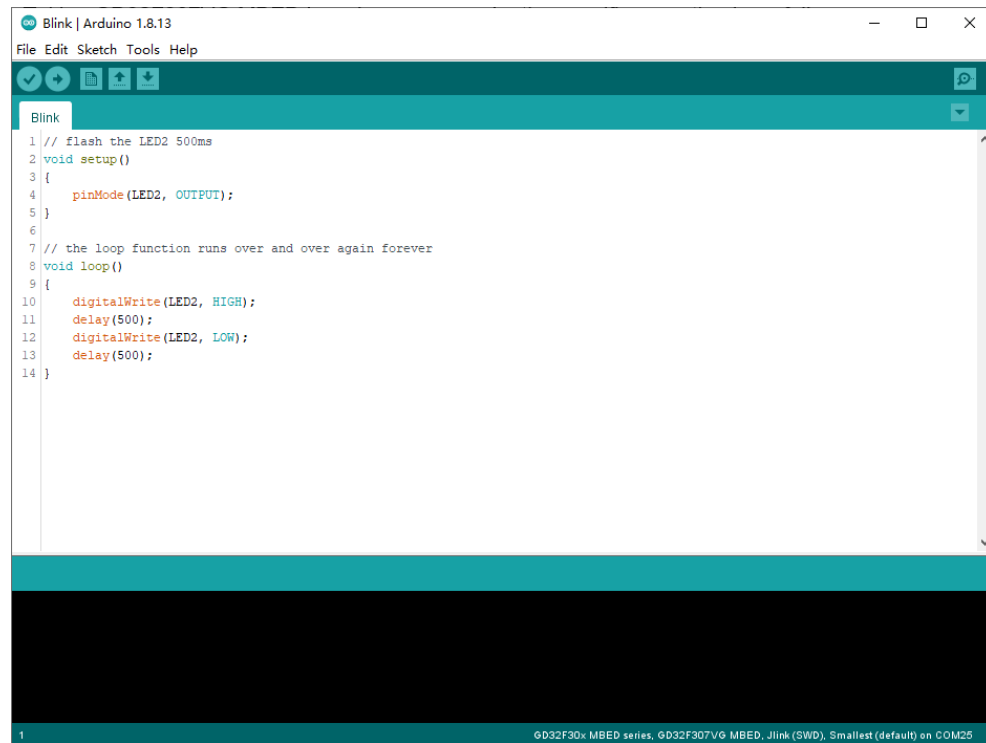


### 3. Develop gd32 Arduino project

Taking GD32F307VG MBED board as an example, the specific operation is as follows.

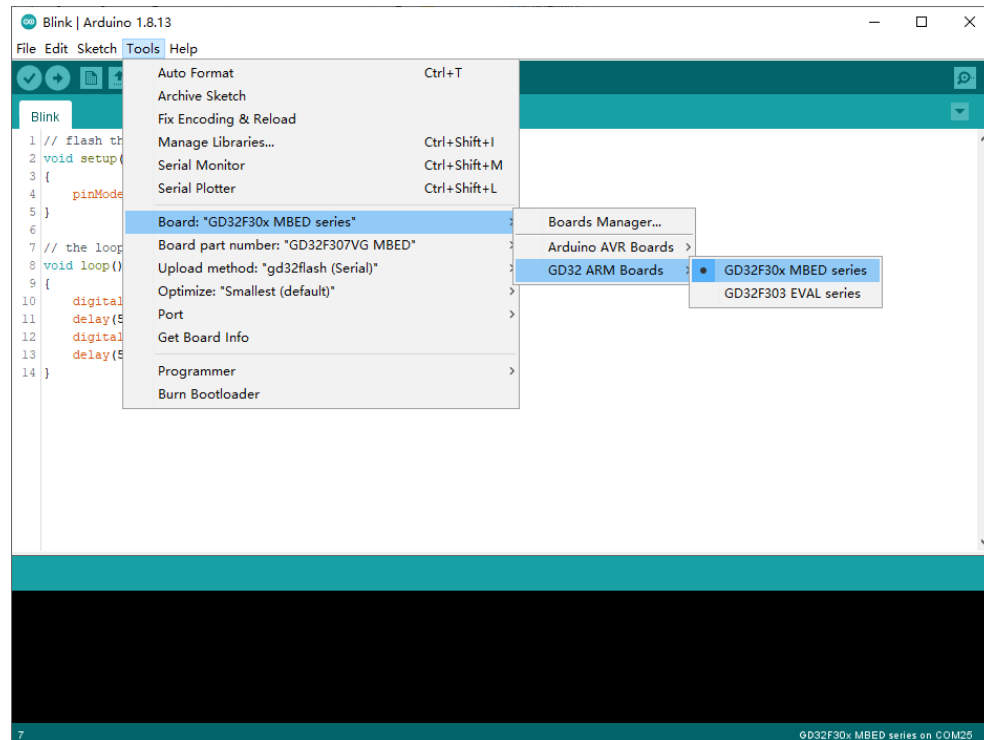
1. Open the Arduino IDE

**Figure 3-1. Open the Arduino IDE**



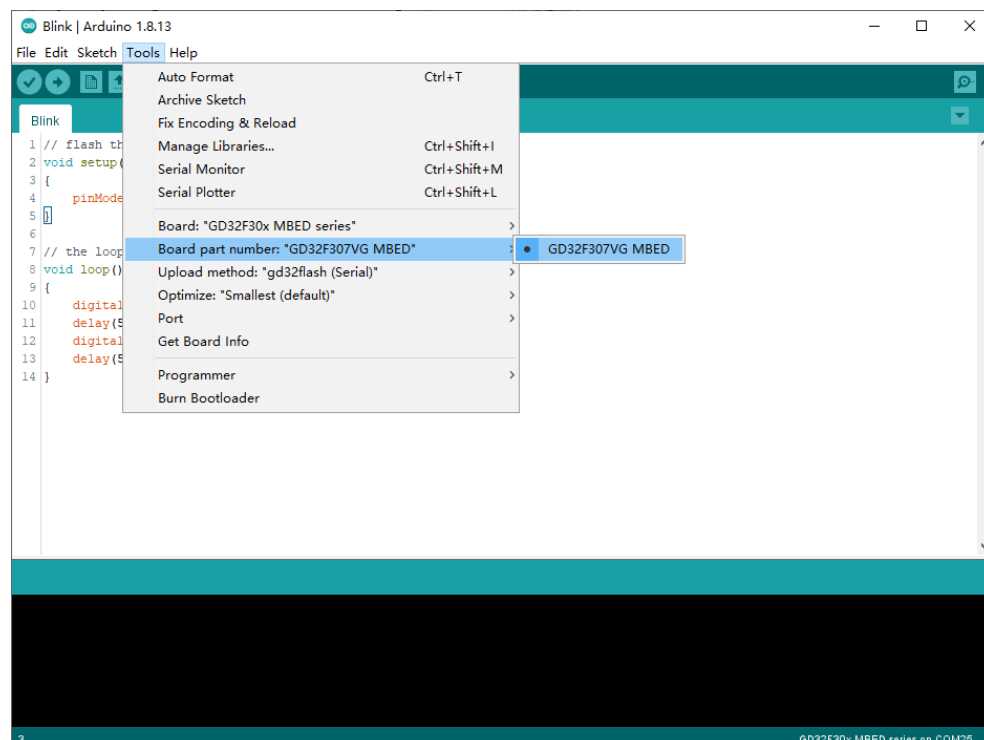
### 2. Select the GD32 MCU development board series

**Figure 3-2. Select the board series**



### 3. Select the specific GD32 MCU development board

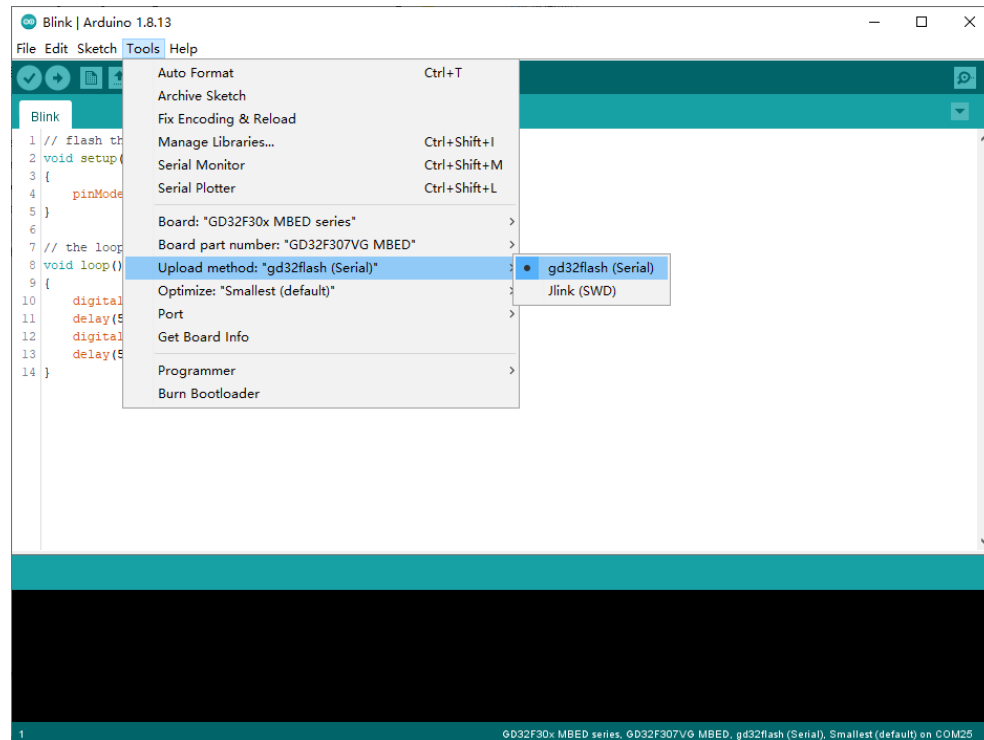
**Figure 3-3. Select the specific board**



### 4. Select the GD32 MCU upload method

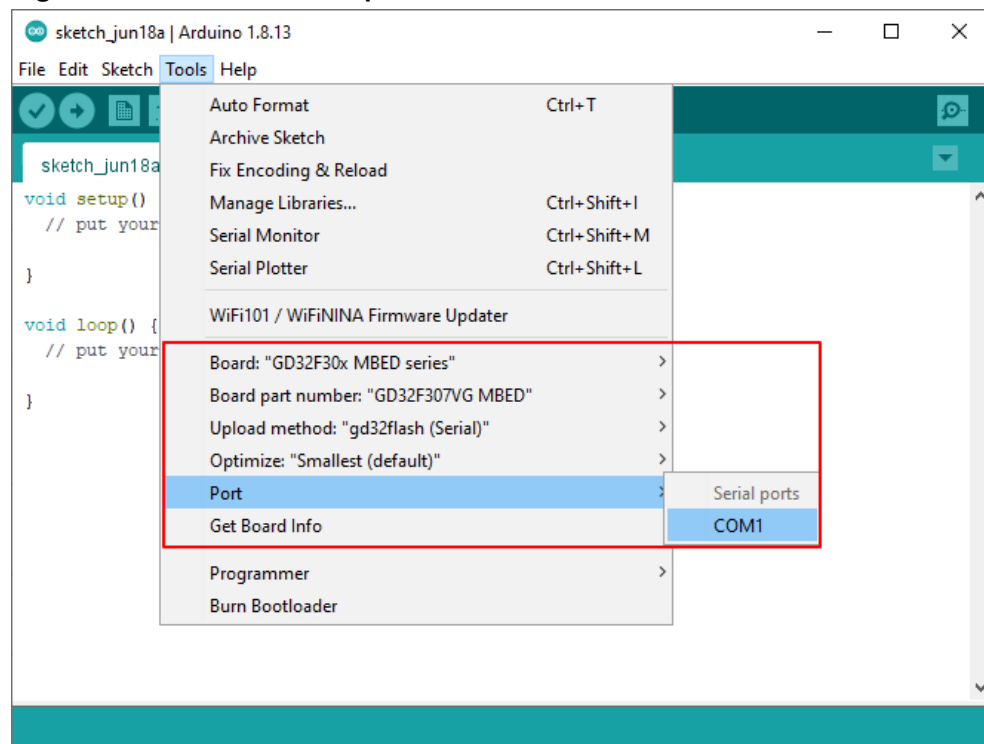
Users can select serial or jlink upload methods. For GD32F307VG MBED board, if use serial upload method, you need connect PD5 pin and PD6 pin to RX and TX of a serial port respectively.

**Figure 3-4. Select the download method**



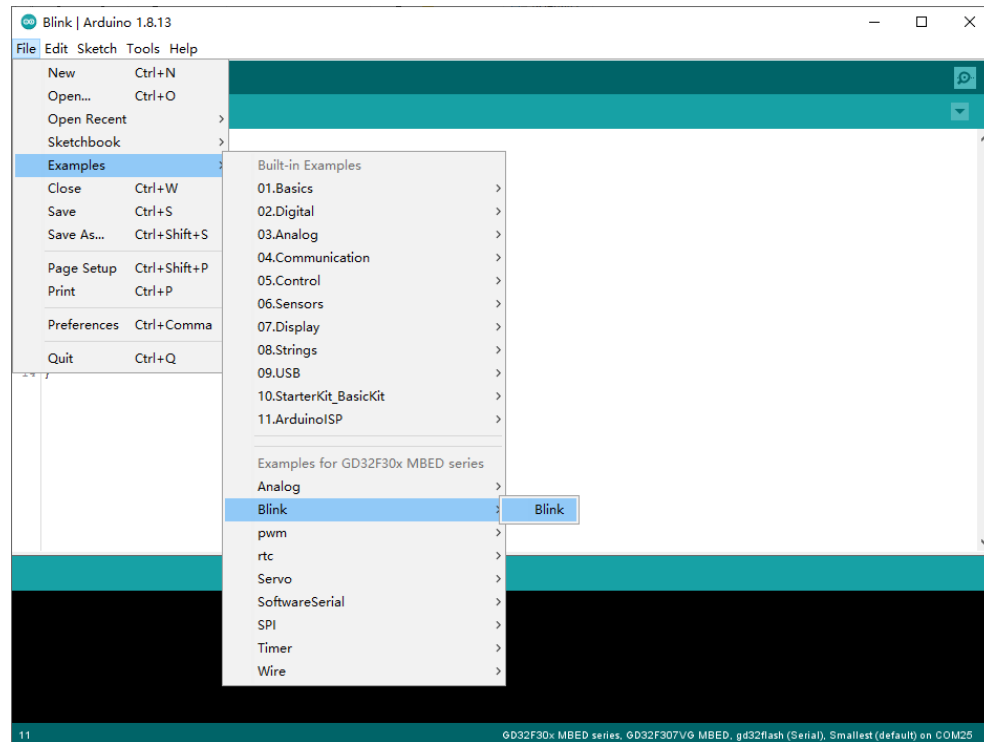
5. Select the GD32 MCU serial port

**Figure 3-5. Select the serial port**



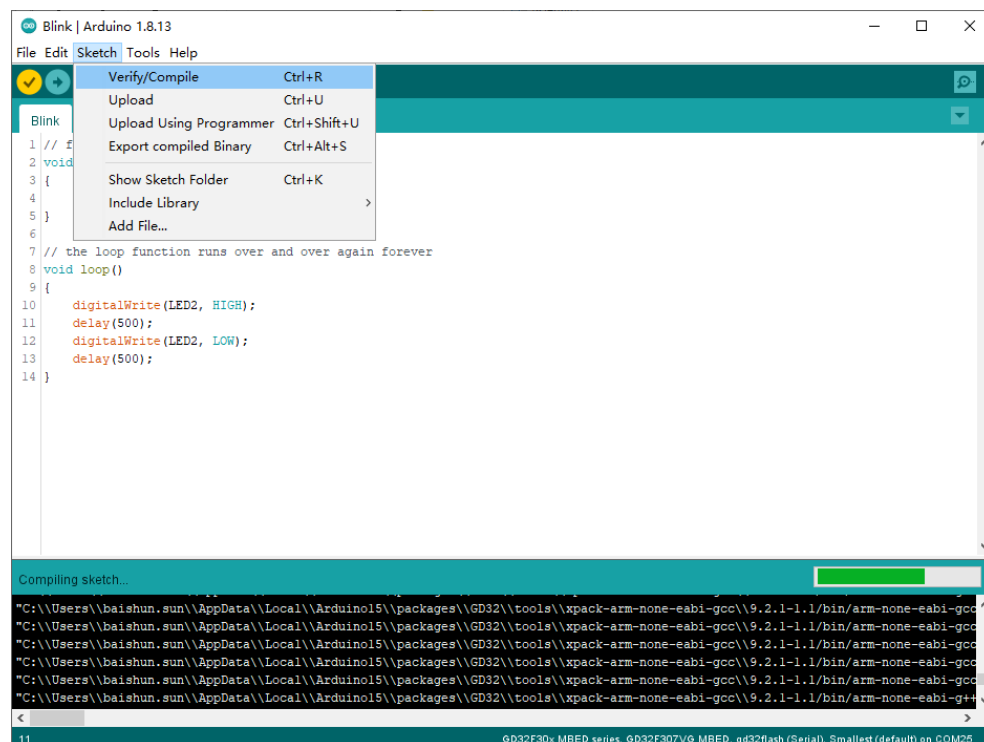
6. Select the GD32 MCU development board example, eg. Blink.

**Figure 3-6. Select the board example**



7. Compile the project

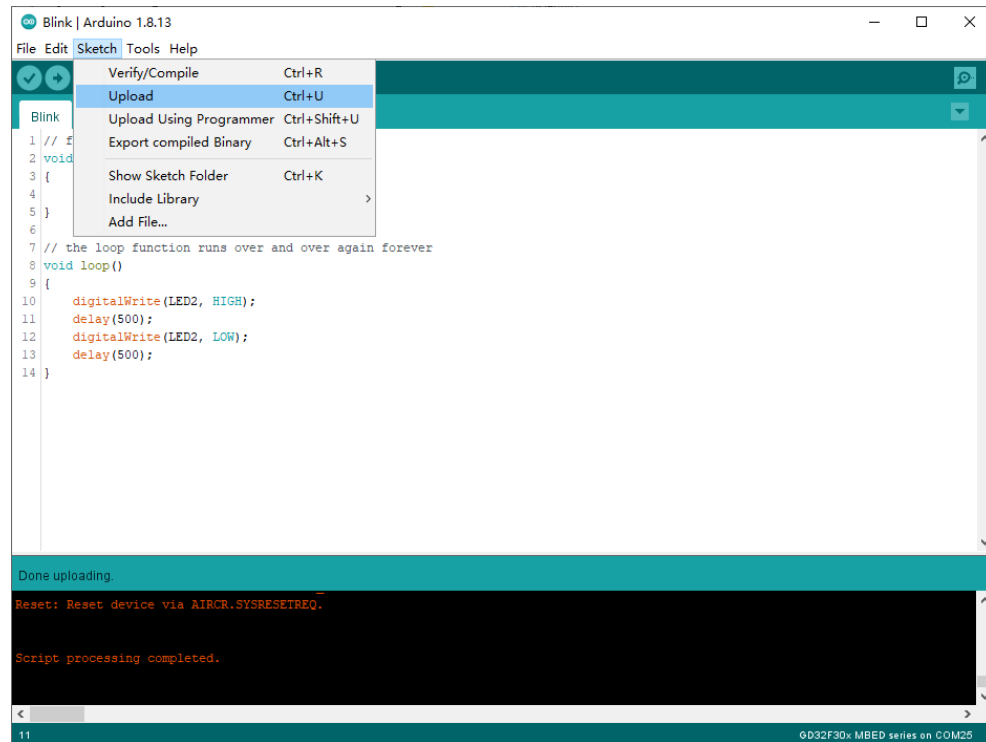
**Figure 3-7. Compile the project**



8. Upload the project

When the Blink sketch uploading is done, the LED2 on the board will flash every 500ms.

**Figure 3-8. Upload the project**



## 4. Download Program to GD32F307-MBED board

### 4.1. gd32flash (Serial)

In GD32F307 series, the boot loader is located in the internal boot ROM memory (system memory). It is used to reprogram the Flash memory by using USART0 (PA9 and PA10), USART1 (PD5 and PD6) and USBFS (PA9, PA11 and PA12) is available for boot functions. In GD32F307-MBED board, since PA9 and PA10 are occupied, PD5 and PD6 are suitable.

Choose upload method: gd32flash (Serial). Jump the BOOT0 jumper cap to 1-2, BOOT1 jumper cap to 2-3. Connect PD5 to serial TX and PD6 to serial RX. Refer to [Table 4-1. Boot modes](#) and [Figure 4-1. Description of GD32F307-MBED board](#) for details. The programming result is as shown in [Figure 4-2. Programming successfully using gd32flash \(Serial\) upload method](#).

**Table 4-1. Boot modes**

Selected boot source	Boot mode selection pins	
	Boot1	Boot0
Main Flash Memory	x	0
Boot loader	0	1
On-chip SRAM	1	1

Figure 4-1. Description of GD32F307-MBED board

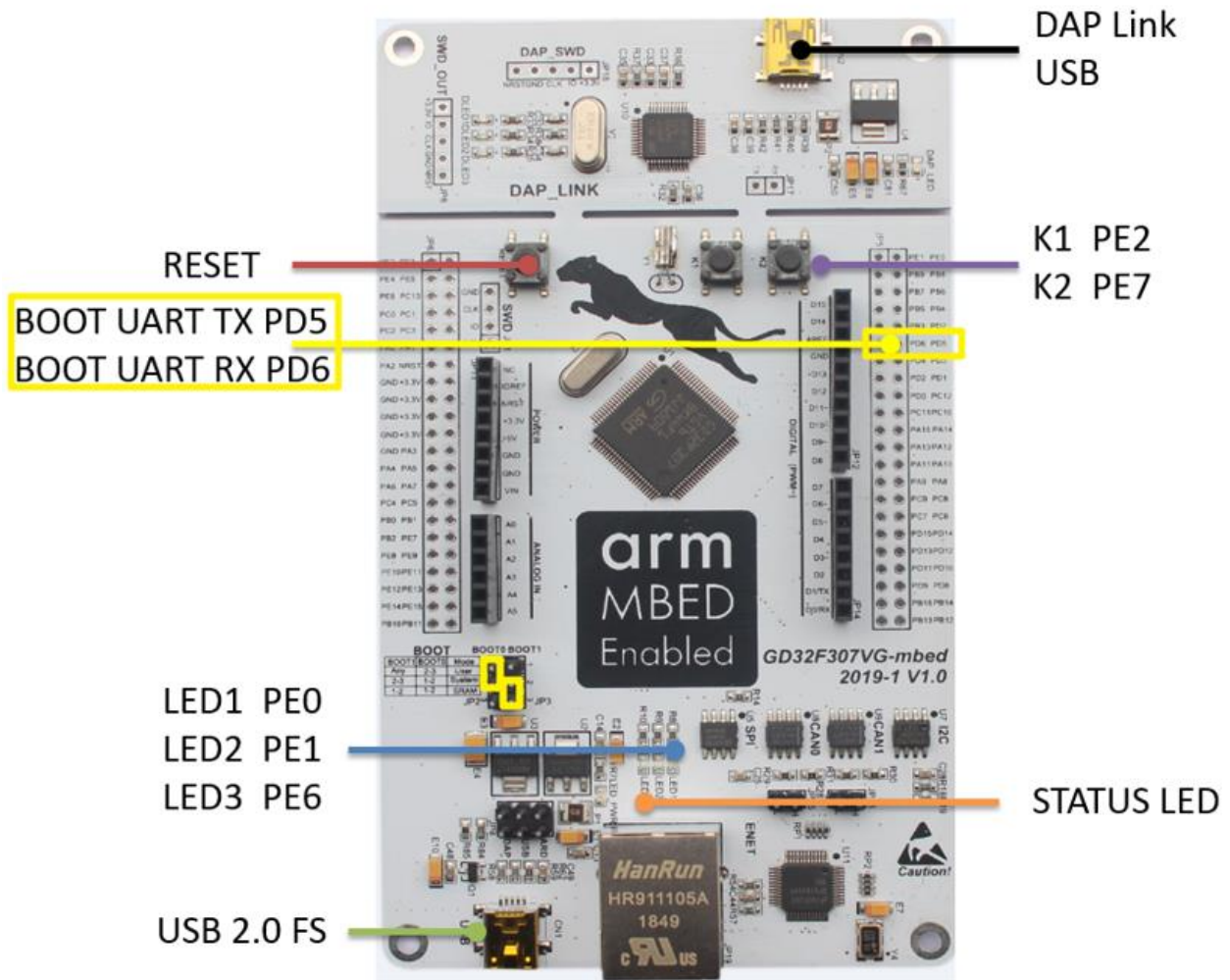


Figure 4-2. Programming successfully using gd32flash (Serial) upload method

```

Opening port      [OK]

Device  GD32F307VGT6

Disabling write protection      [OK]

Resetting device      [OK]

DOWNLOADING ...

Downloading      page 0      8000000      size 2.00      <KB>      [OK]
Downloading      page 1      8000800      size 2.00      <KB>      [OK]
Downloading      page 2      8001000      size 2.00      <KB>      [OK]
Downloading      page 3      8001800      size 1.55      <KB>      [OK]

2.892000 seconds

VERIFYING...

Verifying      page 0      8000000      size 2.00      <KB>      [OK]
Verifying      page 1      8000800      size 2.00      <KB>      [OK]
Verifying      page 2      8001000      size 2.00      <KB>      [OK]
Verifying      page 3      8001800      size 1.55      <KB>      [OK]

1.782000 seconds

```

## 4.2. JLink (SWD)

Choose upload method: JLink (SWD). Jump the BOOT0 jumper cap to 2-3, BOOT1 jumper cap to 2-3. The SWD port is as shown in [Figure 4-3. Debugging port of GD32F307-MBED board](#). Use SWD connection between JLINK and GD32 MCU. The programming result is as shown in [Figure 4-4. Programming successfully using JLink \(SWD\) upload method](#).



Figure 4-3. Debugging port of GD32F307-MBED board

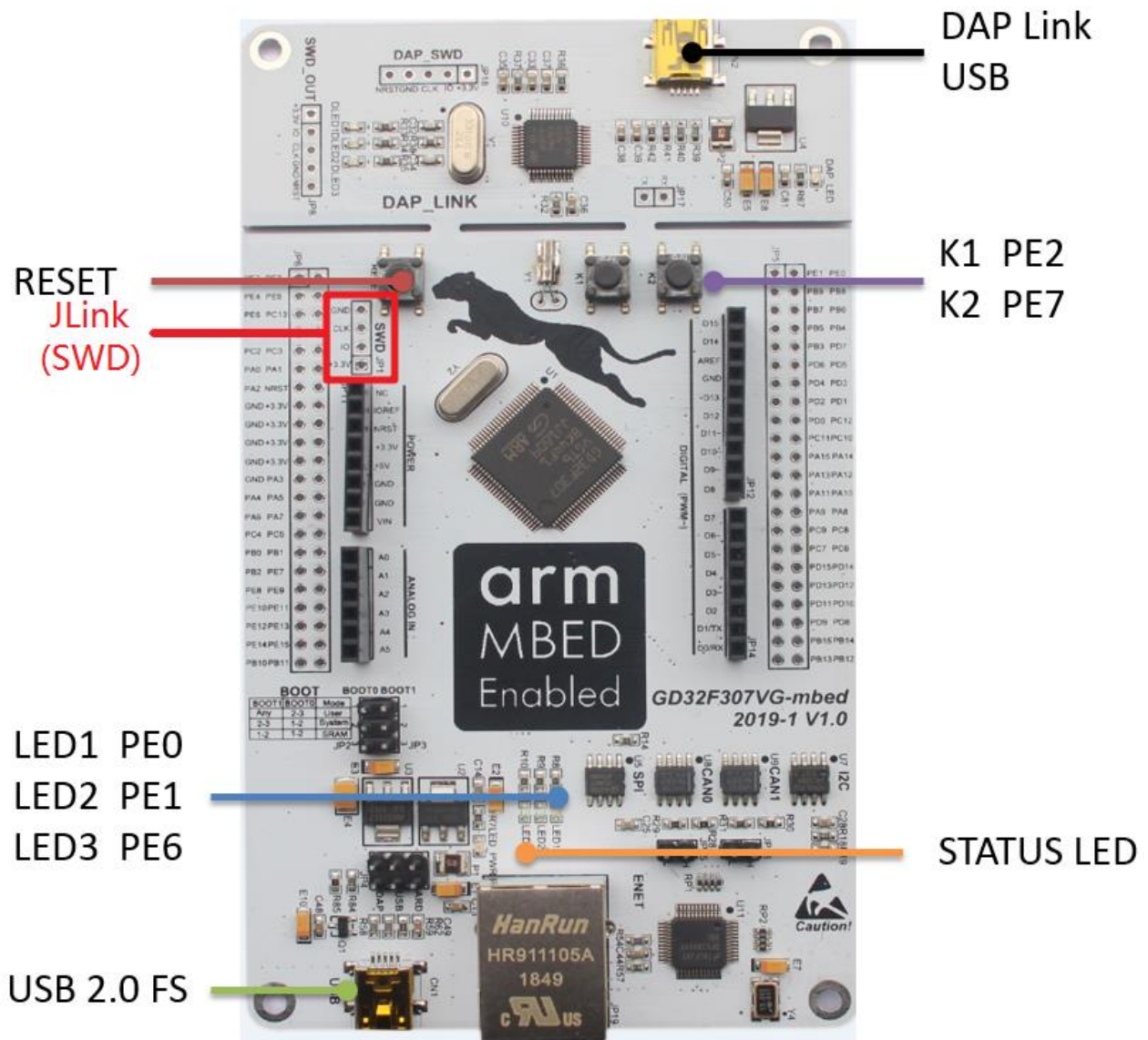


Figure 4-4. Programming successfully using JLink (SWD) upload method

```
J-Link Command File read successfully.
Processing script file...

J-Link connection not established yet but required for command.
Connecting to J-Link via USB...O.K.
Firmware: J-Link V9 compiled May 17 2019 09:50:41
Hardware version: V9.40
S/N: 59400616
License(s): RDI, FlashBP, FlashDL, JFlash, GDB
VTref=3.346V
Target connection not established yet but required for command.
Device "GD32F307VG" selected.

Connecting to target via SWD
Found SW-DP with ID 0x2BA01477
Found SW-DP with ID 0x2BA01477

***** Error: DAP error while reading DP-Ctrl-Stat register.
Found SW-DP with ID 0x2BA01477
Found SW-DP with ID 0x2BA01477
Cannot connect to target.

Target connection not established yet but required for command.
Device "GD32F307VG" selected.

Connecting to target via SWD
Found SW-DP with ID 0x2BA01477
Found SW-DP with ID 0x2BA01477
Found SW-DP with ID 0x2BA01477
Found SW-DP with ID 0x2BA01477
Scanning AP map to find all available APs
AP[0]: Stopped AP scan as end of AP map seems to be reached
Iterating through AP map to find AHB-AP to use
Cannot connect to target.

Target connection not established yet but required for command.
Device "GD32F307VG" selected.

Connecting to target via SWD
Found SW-DP with ID 0x2BA01477
Scanning AP map to find all available APs
AP[0]: Stopped AP scan as end of AP map seems to be reached
Iterating through AP map to find AHB-AP to use
Found SW-DP with ID 0x2BA01477
Found SW-DP with ID 0x2BA01477
Found SW-DP with ID 0x2BA01477
Cannot connect to target.

Script processing completed.
```

## 5. Revision history

Table 5-1. Revision history

Revision No.	Description	Date
1.0	Initial Release	Jul.1, 2021

## Important Notice

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